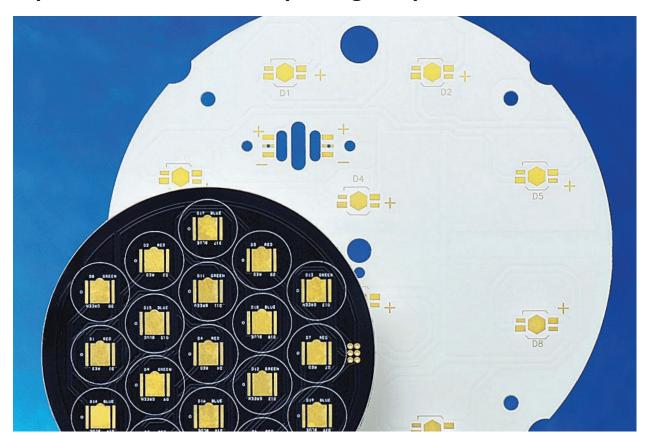
HPL-03015 (HIGH POWER LIGHTING)

Superior Dielectric Lowers Operating Temperatures



Benefits

- Very low thermal resistance of 0.02°Cin²/W (0.13°Ccm²/W)
- High thermal conductivity of 7.5 W/m-K
- High temperature applications
- Lead-free solder compatible
- Eutectic AuSn compatible
- RoHS compliant and environmentally green
- Available on all aluminum and copper metal substrates

Bergquist introduces a new high thermal performance dielectric into its comprehensive Thermal Clad metal core PCB (MCPCB's) line. HPL is a dielectric specifically formulated for high power lighting LED applications with demanding thermal performance requirements. This thin dielectric at 0.0015" (38µm) has an ability to withstand high temperatures with a glass transition of 185°C and phenomenal thermal performance of 0.30°C/W.

Bergquist Thermal Clad Metal Core PCB's minimize thermal impedance and conduct heat more effectively and efficiently than standard printed wiring boards (PWB's). The low thermal impedance of Thermal Clad dielectrics outperforms other PCB materials and offers a cost effective solution eliminating additional LEDs for simplified designs and an overall less complicated production process. Use of Thermal Clad results in lower operating temperatures substantially extending LED lifetimes and offers better durability for high power lighting applications.





HPL-03015 (HIGH POWER LIGHTING)

HPL Typical Values		
HPL-03015	VALUE	TEST METHOD
THERMAL PROPERTIES		
Product Thermal Conductivity	7.5 W/m-K	MET 5.4-01-40000
Dielectric Thermal Conductivity	3.0 W/m-K	ASTM D5470
Thermal Resistance	0.02°C-in²/W (0.13°C-cm²/W)	ASTM D5470
Thermal Impedance	0.30°C/W	MET-5.4-01-40000
Glass Transition	185°C	ASTM E1356
Max Operating Temp.	140°C	U.L. 796
Max Soldering Temp.	325°C	U.L. 796
ELECTRICAL PROPERTIES		

Dielectric Constant	6.6	ASTM D150
Dissipation Factor	0.003/0.005 (@1KHz/1MHz)	ASTM D150
Capacitance	925 pF/in ² (140pF/cm ²)	ASTM D150
Volume Resistivity	l¹⁴Ω-m	ASTM D257
Surface Resistivity	I¹³ Ω/sq	ASTM D257
Breakdown Voltage	5.0 kVAC	ASTM D149

MECHANICAL PROPERTIES

Color	Off-white	Visual
Dielectric Thickness	0.0015" (38 μm)	Visual
Peel Strength@25C	5 lb/in (0.9 N/mm)	ASTM D2861
CTE in XY/Z Axis <tg< th=""><th>35 μm/m°C</th><th>ASTM D3386</th></tg<>	35 μm/m°C	ASTM D3386
CTE in XY/Z Axis >Tg	85 μm/m°C	ASTM D3386
Storage Modulus	18/12 GPa (@25°C/150°C)	ASTM 4065

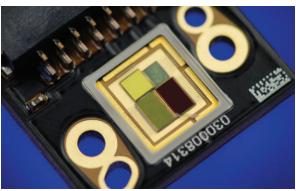
CHEMICAL PROPERTIES

Water Vapor Retention	0.11% wt.	ASTM E595
Out-Gassing Total Mass Loss	0.15% wt.	ASTM E595
Collect Volatile Condensable Material	< 0.01% wt.	ASTM E595

AGENCY RATINGS & DURABILITY

U.L. Maximum Operating Temperature	140°C	U.L. 796
U.L. Flammability	V-0	U.L. 94
Comparative Tracking Index (CTI)	0/600	ASTM D3638/ IEC60112
Solder Limit Rating	325°C/60 seconds	U.L. 796

Please test this material in your application. Bergquist provides this engineering data for design guidance only. Depending upon your application, the observed material performance may vary





High Power LED applications using Thermal Clad.

Applications

- High watt-density applications where achieving low thermal resistance is required
- Backlighting
- Headlamps
- LED applications

MET-4.5-01-40000 Test Thermal Performance of Insulated Metal Substrates (IMS) TO-220 Set-up

